



# SPECIFICATION

# PN: KSE-6K632768KDY240ZA3

#### Crystal Resonators JU206/308 KHZ 6K6 Series

#### FEATURE

- Best suited for portable devices with low current consumption.
- For a clock source in digital equipments.
- RoHS Compliant / Pb Free.

### **ELECTRICAL SPECIFICATIONS**

Frequency range	32.768KHz		
Package	2x6mm		
Frequency Tolerance (at 25°C)	±20ppm		
ESR	50KΩ Max		
Turnover Temperature	25 ± 5°C		
Frequency Temperature Curve	[-0.035±0.01]ppm/°C <sup>2</sup>		
OperableTemperature Range	-40°C to +85 °C		
Storage Temperature Range	-40 °C to +85 °C		
Shunt Capacitance (C0)	1.75pF Typical		
Dynamic Capacitance (C1)	0.0035fF Typical		
Driver Level (DL)	1 µW Typical		
Capacitance Ratio C0/C1	500 Typical		
Quality Factor Q	60000Typical		
Load Capacitance(CL)	12.5PF		
Insulation Resistance	500Mohm Min DC=100V± 15V(Pin to Pin,Pin to case)		
Aging @25°C 5st year (Max)	±3ppm/year		

#### DIMENSION (Unit: mm)



#### MARK



#### Frequency VS Temperature Curve

#### **Oscillation Circuit**





#### Environment-proof • Mechanical property

No	ltem	Specifications	Conditions		
1	High temperature storage	∆f/f =±5 × 10-6	-6 After storage under 85°C for 500 hrs, measure at room temperature.		
2	Low temperature storage	∆f/f =±5 × 10-6	After storage under -40°C for 500hrs, measure at room temperature	1	
3	High temperature and high humidity storage	∆f/f =±5 × 10-6	After storage under 60°C±2°C, 90 to95% RH for 500 hrs, measure at room temperature。		
4	Thermal shock resistance $\Delta f/f = \pm 5 \times 10-6$		Measured at room temperature after20 cycles25°C ⇔+80°C for 30 minutes.		
5	5 Mechanical shock resistance $\triangle f/f = \pm 5 \times 10-6$ Measure after free drop of the RESONA times from the height of 75cm onto a we		Measure after free drop of the RESONATOR three times from the height of 75cm onto a wooden board.	2	
6	Vibration resistance	∆f/f =±5 × 10-6	Amplitude 1.5mm and $10 \sim 60$ Hz with cycle time $2 \sim 3$ minutes in 3 direction (X,Y,and Z axis)each for 2 hrs.	2	
7	Resistance to soldering heat $\triangle f/f = \pm 5 \times 10-6$ lease the		Measured at room temperature after immersing the lead wire in a soldering bath of $300^{\circ}C \pm 10^{\circ}C$ for 5 seconds up to a position where it is2mm away from the root of the plug.		
8	Tensile strength of lead wire $\triangle f/f = \pm 5 \times 10-6$ Apply wire's		Apply a load of 500g for 30 seconds in the lead wire's axial direction.	2	
9	Bending strength of lead wire	ad wire $\triangle f/f = \pm 5 \times 10-6$ Bending cycle : $0 \rightarrow 45 \rightarrow 0 \rightarrow 45 \rightarrow 0 \rightarrow 45 \rightarrow 0 \rightarrow 10^{\circ}$		2	
10	Solderability of lead wire	A minimum 95% of the area to be coated with solder	Apply resin-flux contained-solder to a soldering iron of 280°C±5°C for 5 seconds.	2	

Note:

1. The adove tests no. 1 to 9 must be conducted independently (not series tests)

2. \*1: Measure after 24 hours soak at room temperature .

3. \*2: Measure after 2 hours soak at room temperature .

#### Precautions

(1) Temperature for soldering the lead wire shall not exceed 300  $^\circ$ C and the soldering time shall be within 5 seconds.

(2) Position to be soldered : Solder only the position where the lead wire is1.0mm away from the glass seal. Do not solder the case.

(3) Cutting, bending and

correction of lead wire: The glass seal shall be free of any crack or other damage which may deteriorate the characteristics of RESONATORS.

Rev	Revise contents	Reason	Reviser	Checked	Approved
A1	Initial released				

# REVISION RECORD (KSE-6K632768KDY240ZA3)